



Silicon N-Channel Power MOSFET 
CS8N65F A9H

General Description:

CS8N65F A9H, the silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency. The package form is TO-220F, which accords with the RoHS standard.

Features:

- | Fast Switching
- | Low ON Resistance($R_{DS(on)} \leq 1.3\Omega$)
- | Low Gate Charge (Typical Data: 28nC)
- | Low Reverse transfer capacitances(Typical: 14pF)
- | 100% Single Pulse avalanche energy Test

Applications:

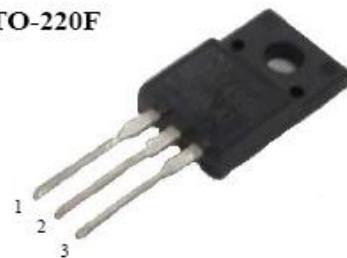
Power switch circuit of adaptor and charger.

Absolute (T_C = 25°C unless otherwise specified):

Symbol	Parameter	Rating	Units
V _{DSS}	Drain-to-Source Voltage	650	V
I _D	Continuous Drain Current	8	A
	Continuous Drain Current T _C = 100 °C	5.5	A
I _{DM} ^{a1}	Pulsed Drain Current	32	A
V _{GS}	Gate-to-Source Voltage	±30	V
E _{AS} ^{a2}	Single Pulse Avalanche Energy	500	mJ
E _{AR} ^{a1}	Avalanche Energy ,Repetitive	40	mJ
I _{AR} ^{a1}	Avalanche Current	2.8	A
dv/dt ^{a3}	Peak Diode Recovery dv/dt	5.0	V/ns
P _D	Power Dissipation	45	W
	Derating Factor above 25°C	0.36	W/°C
T _J , T _{stg}	Operating Junction and Storage Temperature Range	150, -55 to 150	°C
T _L	Maximum Temperature for Soldering	300	°C

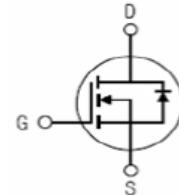
V _{DSS}	650	V
I _D	8	A
P _D (T _C =25 °C)	45	W
R _{DS(ON)Typ}	0.9	Ω

TO-220F



1. Gate 2. Drain 3. Source

Inner Equivalent Principium Chart



**Electrical Characteristics (Tc= 25°C unless otherwise specified):**

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
V _{DSS}	Drain to Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	650	--	--	V
ΔBV _{DSS} /ΔT _J	Bvdss Temperature Coefficient	I _D =250uA, Reference 25°C	--	0.5	--	V/°C
I _{DSS}	Drain to Source Leakage Current	V _{DS} = 650V, V _{GS} = 0V, T _a = 25°C	--	--	1	μA
		V _{DS} = 520V, V _{GS} = 0V, T _a = 125°C	--	--	100	
I _{GSS(F)}	Gate to Source Forward Leakage	V _{GS} = +30V	--	--	100	nA
I _{GSS(R)}	Gate to Source Reverse Leakage	V _{GS} = -30V	--	--	-100	nA

ON Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
R _{DS(ON)}	Drain-to-Source On-Resistance	V _{GS} =10V, I _D =4.0A	--	0.9	1.3	Ω
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	2.0		4.0	V
Pulse width tp≤300μs, δ≤2%						

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
g _{fs}	Forward Trans conductance	V _{DS} =15V, I _D = 4A	--	7	--	S
C _{iss}	Input Capacitance		--	1240	--	pF
C _{oss}	Output Capacitance	V _{GS} = 0V V _{DS} = 25V f = 1.0MHz	--	108	--	
C _{rss}	Reverse Transfer Capacitance		--	14	--	

Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
t _{d(ON)}	Turn-on Delay Time	I _D = 8.0A V _{DD} = 325V V _{GS} = 10V R _G = 9.1Ω	--	13	--	ns
tr	Rise Time		--	15	--	
t _{d(OFF)}	Turn-Off Delay Time		--	40	--	
t _f	Fall Time		--	21	--	
Q _g	Total Gate Charge	I _D = 8.0A V _{DD} = 325V V _{GS} = 10V	--	28	--	nC
Q _{gs}	Gate to Source Charge		--	6	--	
Q _{gd}	Gate to Drain ("Miller") Charge		--	11	--	

**Source-Drain Diode Characteristics**

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
I _S	Continuous Source Current (Body Diode)		--	--	8	A
I _{SM}	Maximum Pulsed Current (Body Diode)		--	--	32	A
V _{SD}	Diode Forward Voltage	I _S =8.0A, V _{GS} =0V	--	--	1.5	V
t _{rr}	Reverse Recovery Time	I _S =8.0A, T _j = 25°C dI _F /dt=100A/us, V _{GS} =0V	--	556	--	ns
Q _{rr}	Reverse Recovery Charge		--	3.4	--	uC
Pulse width t _p ≤300μs, δ≤2%						

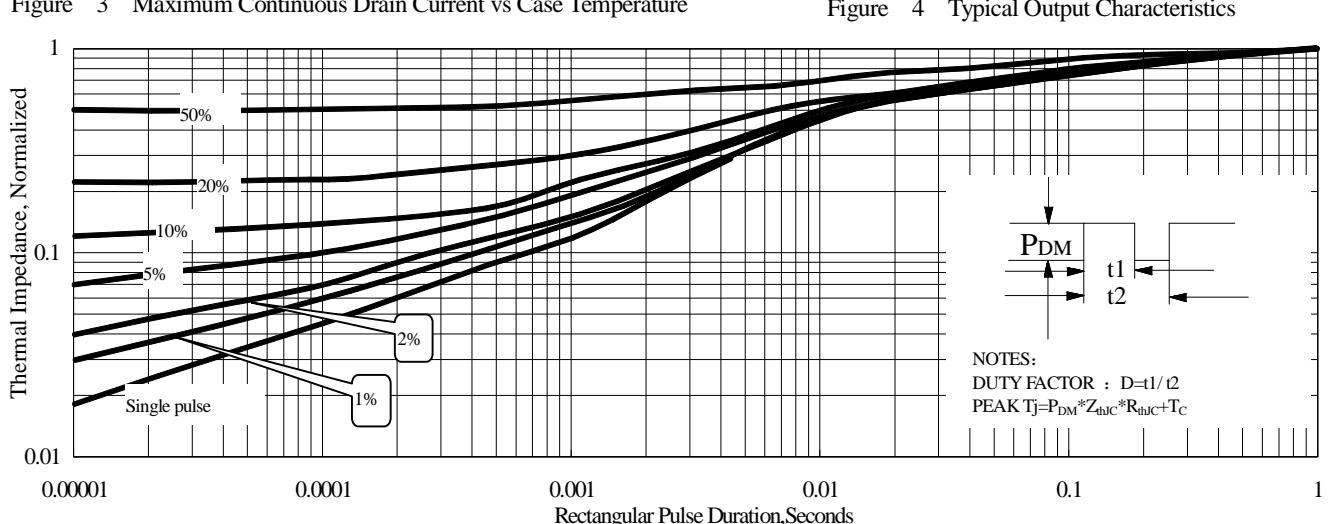
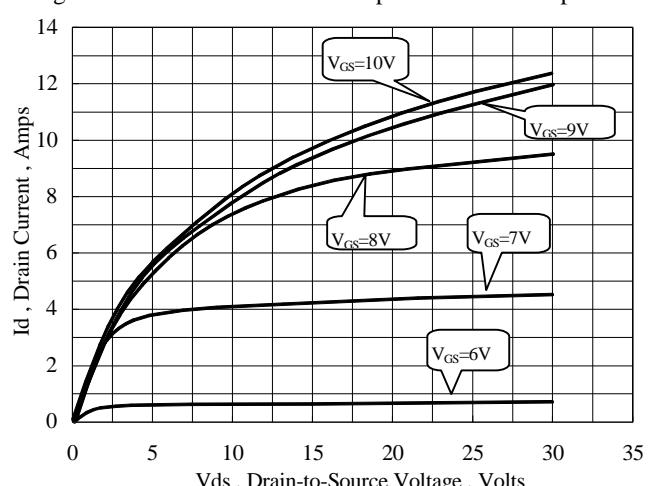
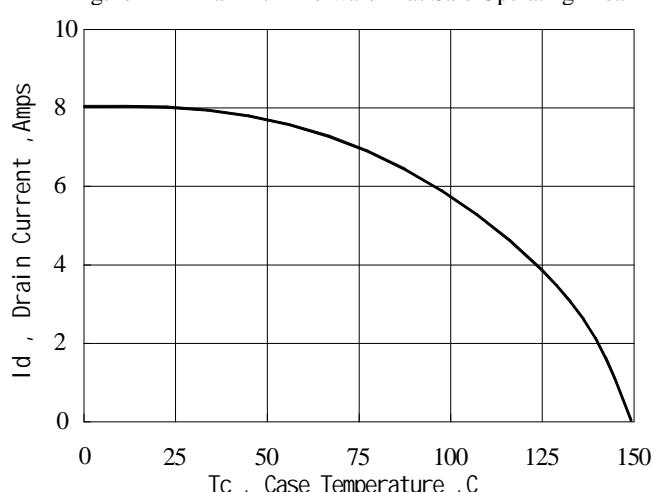
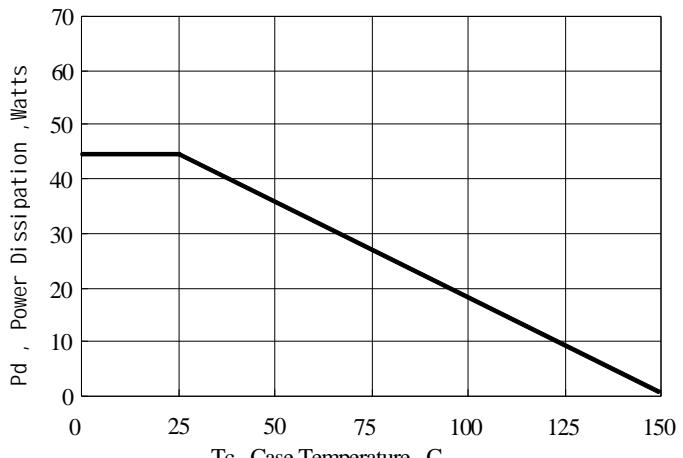
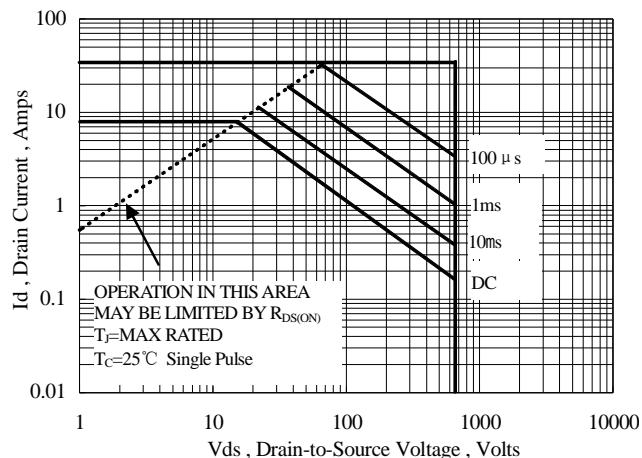
Symbol	Parameter	Typ.	Units
R _{θJC}	Junction-to-Case	2.78	°C/W
R _{θJA}	Junction-to-Ambient	100	°C/W

^{a1}: Repetitive rating; pulse width limited by maximum junction temperature

^{a2}: L=10.0mH, I_D=10A, Start T_j=25°C

^{a3}: I_{SD}=8A, di/dt ≤100A/us, V_{DD}≤BV_{DS}, Start T_j=25°C

Characteristics Curve:





CS8N65F A9H

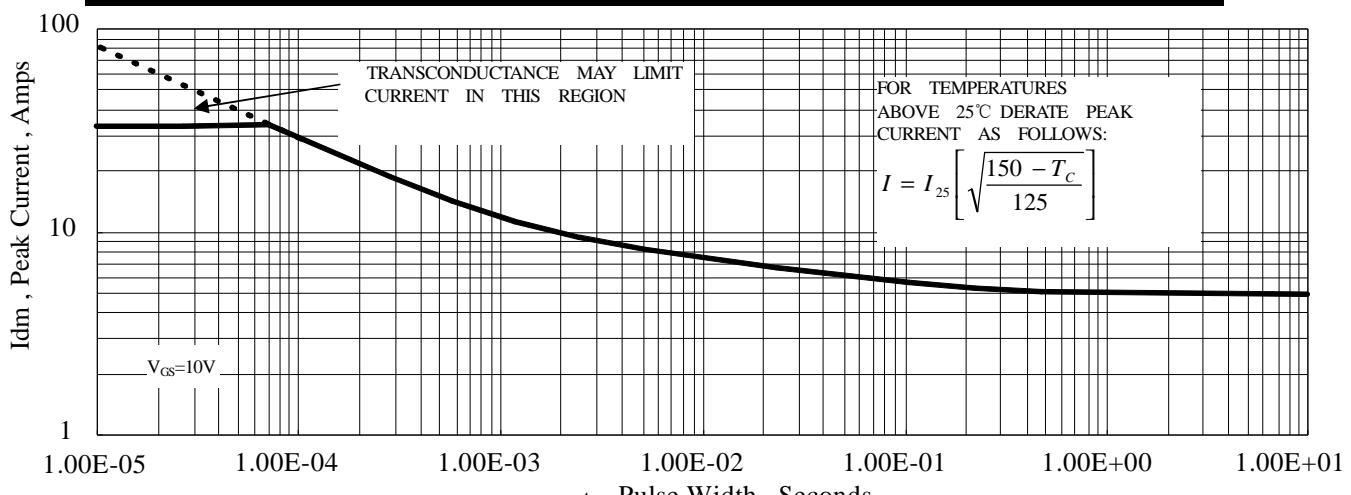


Figure 6 Maximum Peak Current Capability

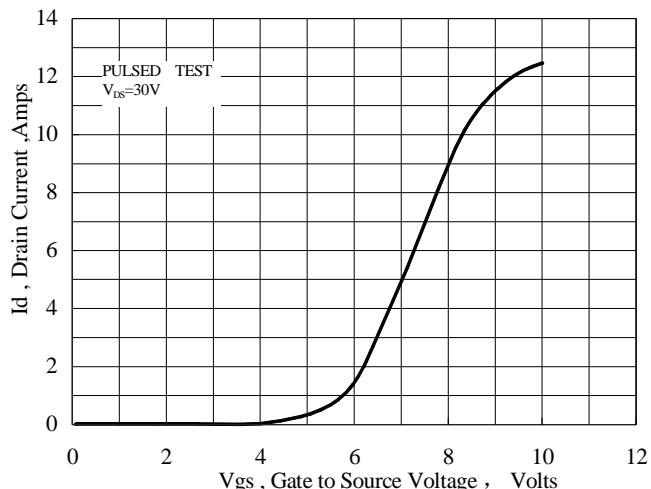


Figure 7 Typical Transfer Characteristics

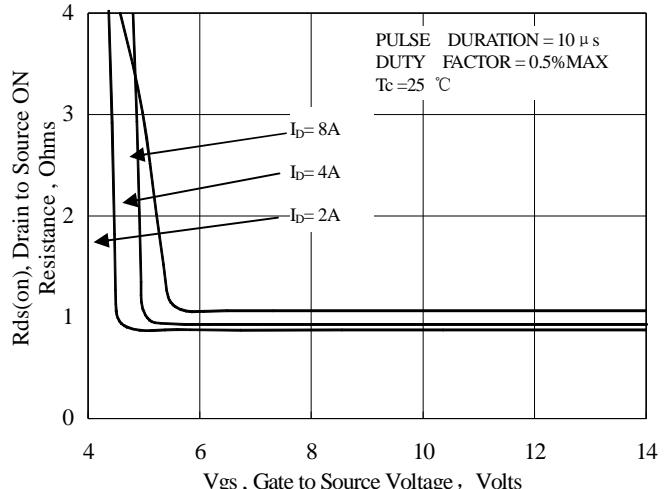


Figure 8 Typical Drain to Source ON Resistance vs Gate Voltage and Drain Current

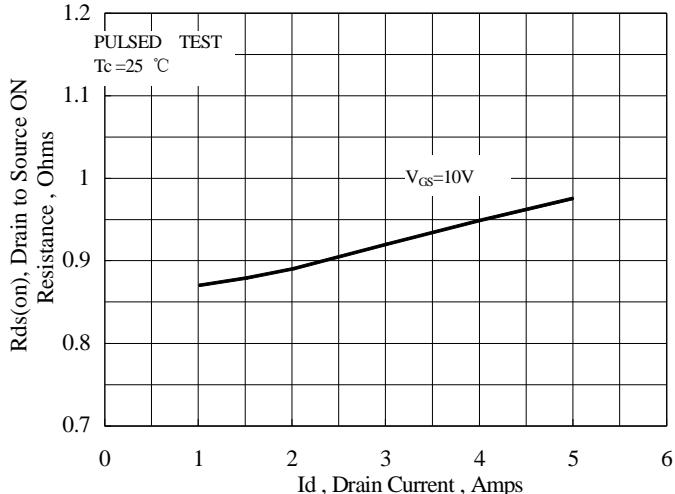


Figure 9 Typical Drain to Source ON Resistance vs Drain Current

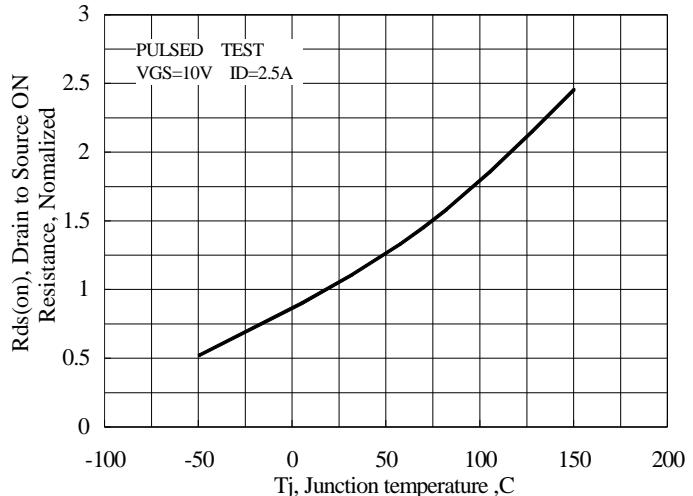


Figure 10 Typical Drain to Source ON Resistance vs Junction Temperature

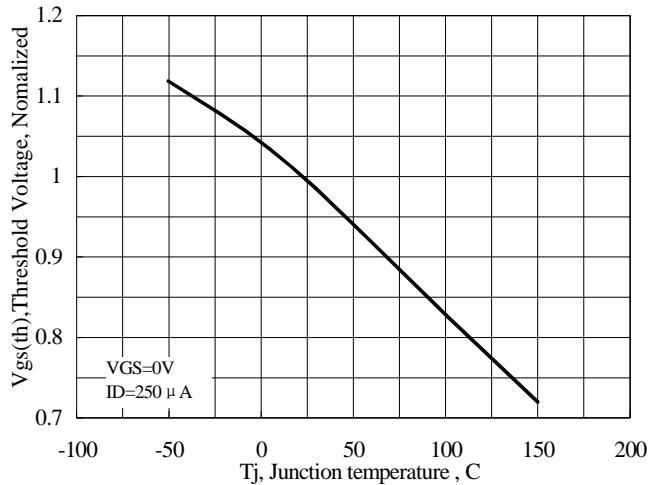


Figure 11 Typical Threshold Voltage vs Junction Temperature

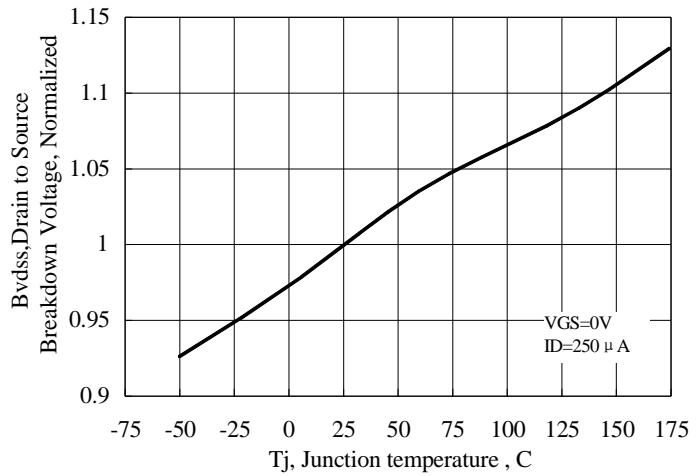


Figure 12 Typical Breakdown Voltage vs Junction Temperature

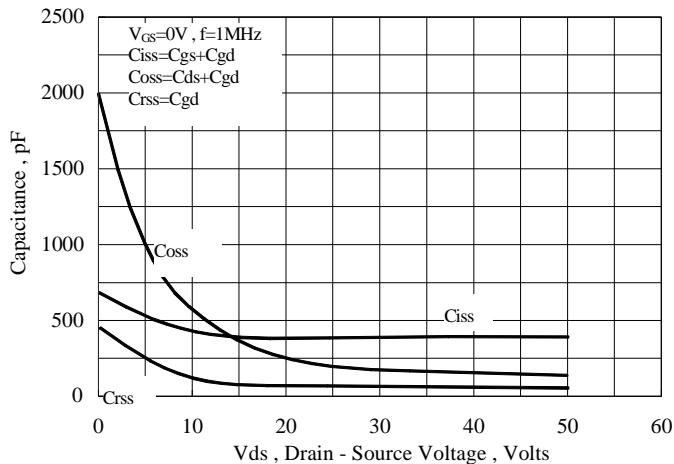


Figure 13 Typical Capacitance vs Drain to Source Voltage

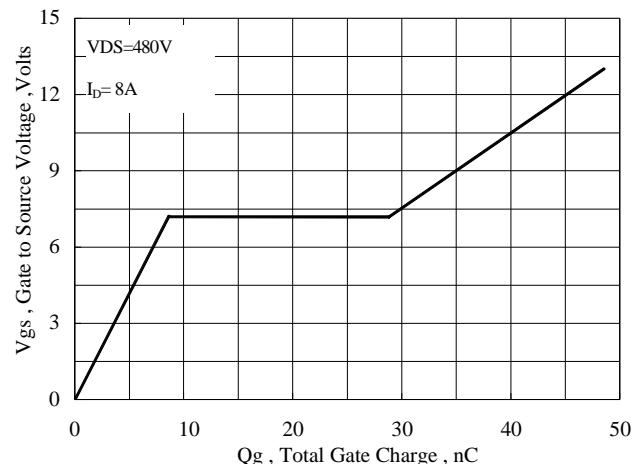


Figure 14 Typical Gate Charge vs Gate to Source Voltage

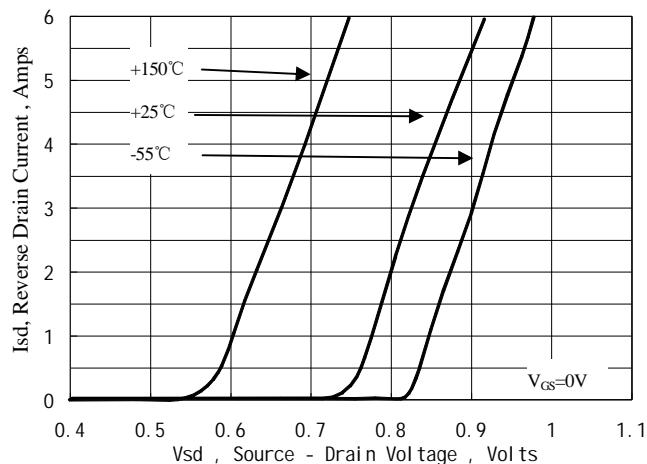


Figure 15 Typical Body Diode Transfer Characteristics

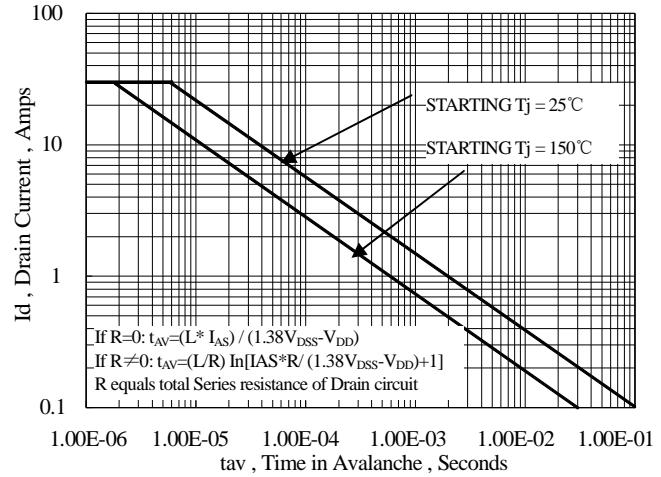


Figure 16 Unclamped Inductive Switching Capability

Test Circuit and Waveform

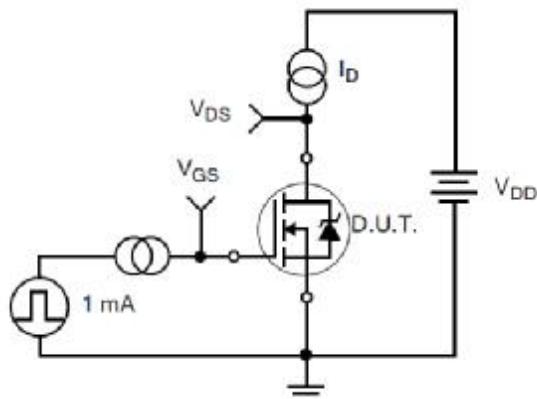


Figure 17. Gate Charge Test Circuit

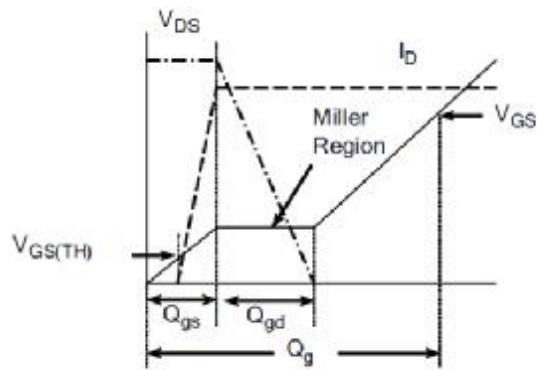


Figure 18. Gate Charge Waveform

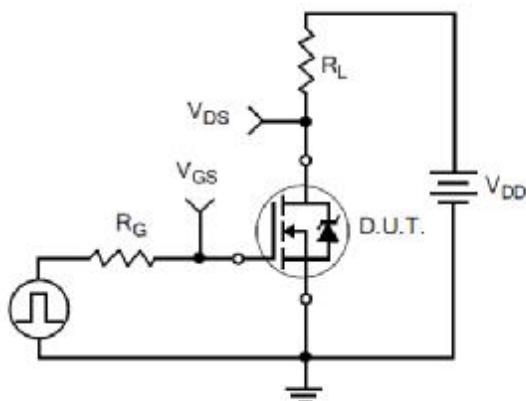


Figure 19. Resistive Switching Test Circuit

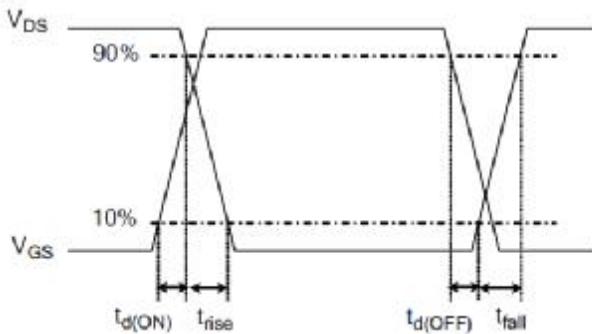


Figure 20. Resistive Switching Waveforms

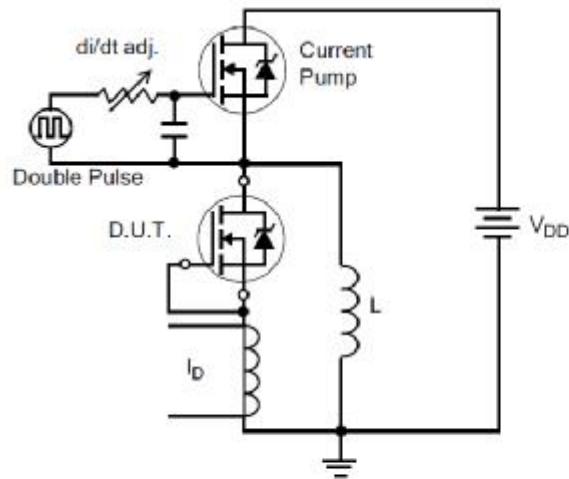


Figure 21. Diode Reverse Recovery Test Circuit



Figure 22. Diode Reverse Recovery Waveform



Figure 23. Unclamped Inductive Switching Test Circuit

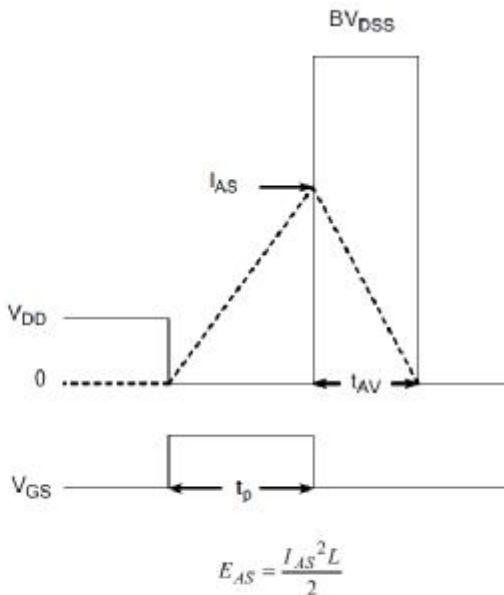
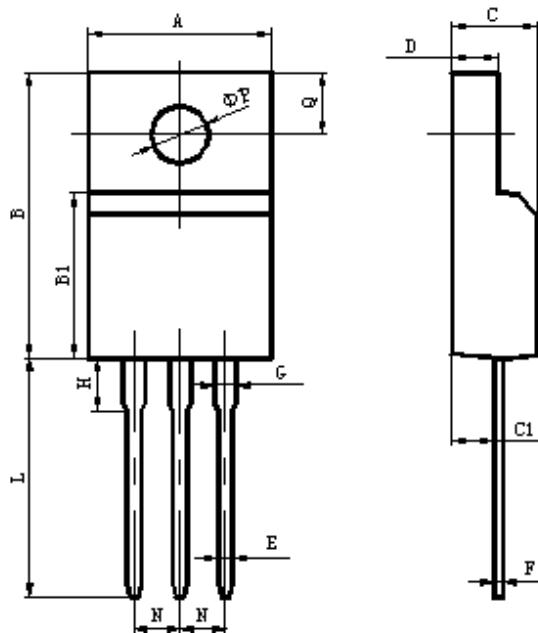


Figure 24. Unclamped Inductive Switching Waveforms



Package Information



Items	Values(mm)	
	MIN	MAX
A	9.60	10.40
B	15.40	16.20
B1	8.90	9.50
C	4.30	4.90
C1	2.10	3.00
D	2.40	3.00
E	0.60	1.00
F	0.30	0.60
G	1.12	1.42
H	3.40	3.80
	2.00	2.40
L	12.00	14.00
	6.30	7.70
N	2.34	2.74
Q	3.15	3.55
Φ P	3.00	3.30

TO-220F Package

**The name and content of poisonous and harmful material in products**

Part's Name	Hazardous Substance					
	Pb	Hg	Cd	Cr(VI)	PBB	PBDE
Limit	≤0.1%	≤0.1%	≤0.01%	≤0.1%	≤0.1%	≤0.1%
Lead Frame	○	○	○	○	○	○
Molding Compound	○	○	○	○	○	○
Chip	○	○	○	○	○	○
Wire Bonding	○	○	○	○	○	○
Solder	×	○	○	○	○	○
Note	<p>○ : means the hazardous material is under the criterion of SJ/T11363-2006.</p> <p>× : means the hazardous material exceeds the criterion of SJ/T11363-2006.</p> <p>The plumbum element of solder exist in products presently, but within the allowed range of Eurogroup's RoHS.</p>					

Warnings

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. It is suggested to be used under 80 percent of the maximum ratings of the device.
2. When installing the heatsink, please pay attention to the torsional moment and the smoothness of the heatsink.
3. VDMOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. This publication is made by Huajing Microelectronics and subject to regular change without notice.

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